COILMX

SPECIFICATION FOR APPROVAL

产品规格承认书

High Current Power Inductor

大电流功率电感

CUSTOMER.	
MODEL NO.	MER2811-150M-D
CUSTOMER'S PART NO.	
LILE NO.	
DATE.	2026.03.06
REVISION.	A/1

CUSTOMER APPROVE		
DATE:		
DRAWING		
DRAWN BY	CHECK BY	APPROVAL BY
林思思	陈健波	曾伟
DATE:2026.03.06		

COILMX
新能源光储充电子磁性元器件制造商

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深圳市迈翔科技有限公司
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COILMX 惠州市迈翔电子有限公司 深圳市迈翔科技有限公司

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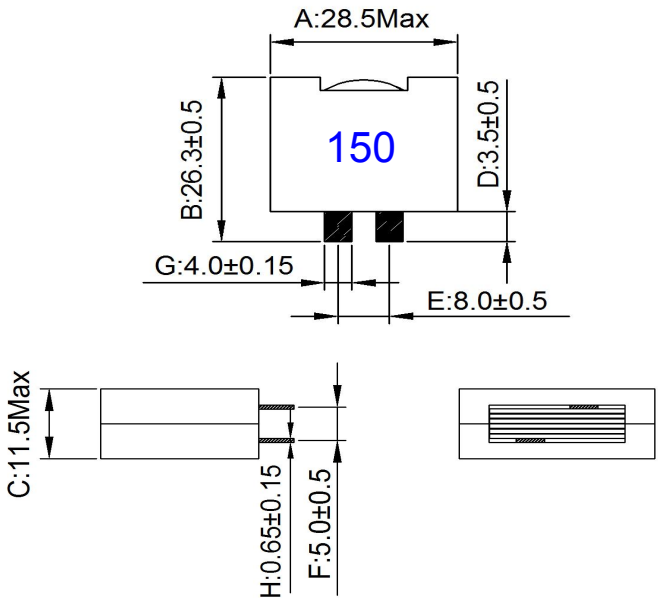
REVISIONS

REW	PROJECT CHANGE	DESCRIPTION	Date
A/0	新版本		2026.01.23
A/1	D尺寸变更	D尺寸由“5.0±0.5”更改为“3.5±0.5”	2026.03.06
	B尺寸变更	B尺寸由“27.8±0.5”更改为“26.3±0.5”	

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1.PRODUCT DIMENSION



UNIT:mm	
A	28.5MAX
B	26.3±0.5
C	11.5MAX
D	3.5±0.5
E	8.0±0.5
F	5.0±0.5
G	4.0±0.15
H	0.65±0.15

2.ELECTRICAL REQUIREMENTS

PARAMETER	SPECIFICATION	CONDITION	TEST INSTRUMENTS
L(uH)	15 ± 20%	100KHz/0.1V	MICROTEST 6377
DCR(mΩ)	4.5MAX	At 25℃	TH16502
I sat(A)	20A TYP L0A*70%	100KHz/0.1V	MICROTEST 6377+6220
I rms(A)	23A TYP △T≤50℃	100KHz/0.1V	MICROTEST 6377+6220

3.MATERIAL LIST

ITEM	MATERIAL	SUPPLIER
CORE	ER2811	LIANFENG
WIRE	220℃扁平线/φ0.65*4.0*6.75TS	TAIYI-JIATENG-SONGYE
SOLDER	TIN-Sn99.95	QIANDAO/HONGXINGWEI

4.CHARACTERISTICS

(1). All test data is based on 25℃ ambient.

(2). DC current(A)that will cause an approximate △T40℃

(3). DC current(A)that will cause L0 to drop approximately 30%Typ

(4). Operating temperature range: -40℃~+125℃

(5).The part temperature (ambient + temp rise)should not exceed 125℃ under worst case operating conditions. circuit design, component.PWB trace size and thickness,airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the den application

5.SPECIAL REQUEST

(1)Lettering 150 on top of the body.

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6.PRODUCT IDENTIFICATION

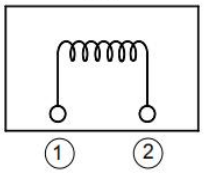
XXX XXXX - XXX

① ② ③

①、 Series name ②、 Product dimensions ③、 Inductance

④、 Tolerance: M±20%，N±30%.

7.ELECTRICAL SCHEMATICS



8.APPLICATION

(1)Low profile,high current power supplies.

(2)Battery powered devices.

(3)DC/DC converters in distributed power systems.

(4)DC/DC converters for field programmable gate array.

9.FEATURES

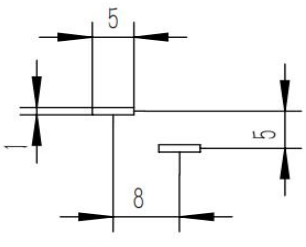
(1)Assemblage design, sturdy structure.

(2)High inductance, high current, low magnetic loss,low ESR, small parasitic capacitance.

(3)Flat wire winding, achieve a low D.C. Resistance.

(4)Temperature rise current and saturation current is less influenced by environment.

10.RECOMMENDED PCB LAYOUT

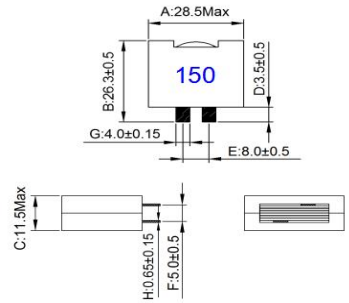


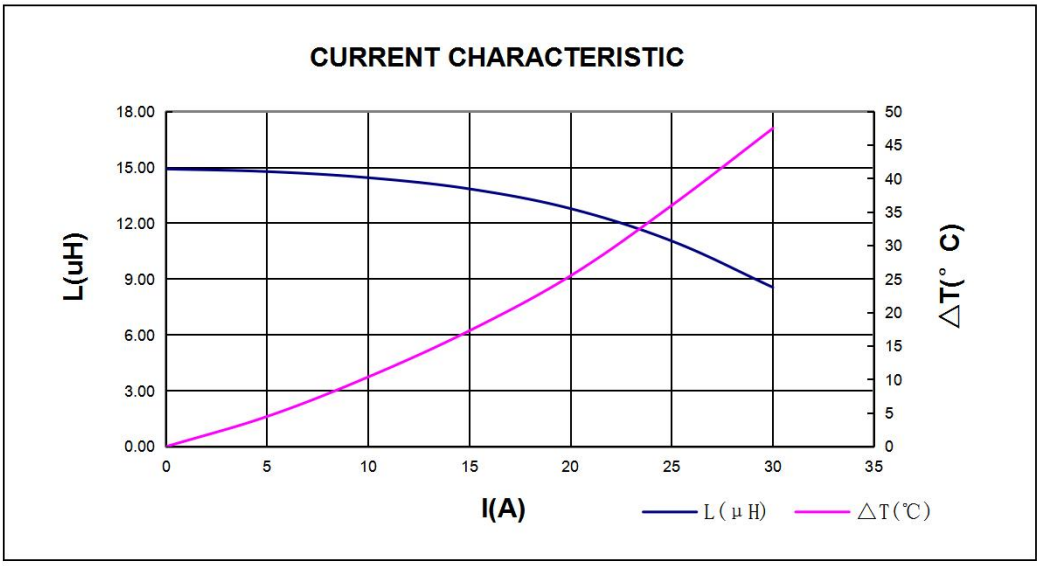
PCB推荐 正视图

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FILE NO.			PART NO.				DATE		2026.03.06	
SORT	ITEM	A	B	C	D	E	F	G		
PRODUCT & DIMENSION	SPEC	28.5MAX	26.3±0.5	11.5MAX	3.5±0.5	8.0±0.5	5.0±0.5	4.0±0.15		
	1	28.05	26.38	11.11	3.62	7.95	4.89	4.01		
	2	28.11	26.42	11.16	3.67	7.96	4.95	4.02		
	3	28.12	26.43	11.18	3.55	8.01	4.85	3.97		
	4	28.12	26.38	11.16	3.59	7.94	4.87	3.98		
	5	28.09	26.38	11.19	3.56	7.96	4.86	3.99		
	X	28.10	26.40	11.16	3.60	7.96	4.88	3.99		
	R	0.07	0.05	0.08	0.12	0.07	0.10	0.05		

ELECTRICAL & REQUIREMENTS	ITEM	L(μH)	DCR (mΩ)	I sat(A)	DC BIAS	Irms	SHAPE:
	SPEC	15 ± 20%	4.5MAX	20A TYP L0A*70%	降幅 %	23A TYP △T≤50℃	
	1	14.49	2.57	12.82	-11.5%	OK	
	2	14.89	2.58	13.03	-12.5%	OK	
	3	14.85	2.57	12.94	-12.9%	OK	
	4	14.93	2.58	12.79	-14.3%	OK	
	5	14.95	2.57	12.89	-13.8%	OK	
	X	1.63	2.57	12.89	-13.0%		
	R	0.46	0.01	0.24	2.8%		





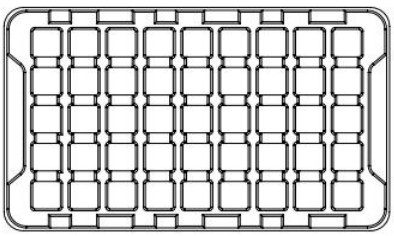
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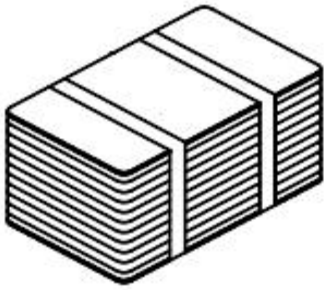
11.可靠性Reliability

项目Item	规格与需求 Specification and Requirement	测试方法Test Method
可焊性 Solder a bility test	沾锡面积不得小于95%上锡面 Terminals area must have 95% min solder coverage	上锡升温曲线Solder heat proof: (1) 预热：160±10℃持续90s Preheating: 160±10℃ for 90 seconds (2) 恒温时段：245±5℃持续2±0.5s Retention time: 245±5℃ for 2±0.5 seconds
振动测试 Vibration test	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1) 振动频率(10Hz 55Hz 10Hz)60s为一个周期 Vibration frequency: (10Hz to 55Hz to 10Hz) in 60 seconds as a period (2) 振动时间 Vibration time: 三维正交坐标系每个方向振动（周期） 循环2小时 Period cycled for 2 hours in each of 3 mutual perpendicular directions (3) 振幅 Amplitude: 1.5 mm Max
冲击测试 Shock test	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1) 最大振幅 Peak value: 100G (2) 脉冲波长 Duration of pulse: 11ms (3) 三维正交坐标系每个方向正负方向冲击3次 Times in each positive and negative direction of 3 mutual perpendicular directions
冷热冲击 Thermal shock	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)重复以上100个循环Repeat 100 cycle as follow (-40±2℃,30±3分钟) 室温5分钟 (-40±2℃,30±3 minutes) Room temperature,5 minutes (+125±2℃,30±3分钟) 室温5分钟 (+125±2℃,30±3 minutes) Room temperature,5 minutes (2)恢复：测试于标准条件下恢复48+4/-0小时 （参考注释1） Recovery:48+4/-0 hours of recovery under the standard condition after the test. (see Note1)
耐高温测试 High temperature life test	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)环境条件：85±2℃ Environment condition : 85±2℃ 应用电流：额定电流 Applied current: Rated current (2)持续时间：1000+4/-0 小时（参考注释1） Duration:1000+4/-0 hours (see Note1)
耐湿测试 Humidity Resistance	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)环境条件：60±2℃ Environment condition : 60±2℃ 湿度：90~95% Humidity:90~95% 应用电流：额定电流 Applied current: Rated current (2)持续时间：1000+4/-0 小时（参考注释1） Duration:1000+4/-0 hours (see Note1)
低温存放测试Low temperature life test	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)存储温度 Store temperature -40±2℃下存放 1000+4/-0 小时 -40±2℃for total 1000+4/-0 hours
高温存放测试High temperature life test	感值变化：不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)存储温度 Store temperature +125±2℃下存放 1000+4/-0 小时 +125±2℃for total 1000+4/-0 hours

12、包装 Packaging

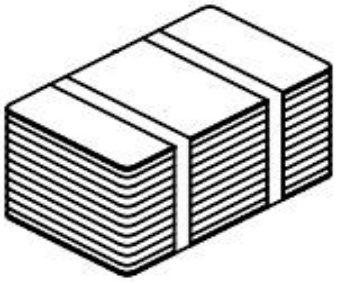


Tray X 7

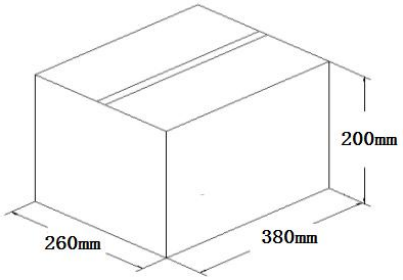


Quantity/Tray:50PCS

Quantity/Bundle:350PCS



Bundle × 1



Quantity/Bundle:350PCS

Quantity/Carton:350PCS

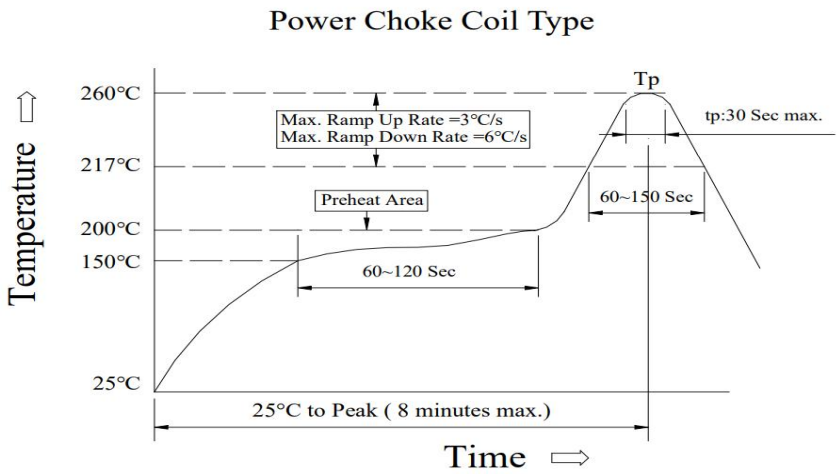
包装数量packing quantity

Product Series 产品系列	Quantity/Tray 数量/盘	Quantity/Bundle 数量/捆	Quantity/Carton 数量/箱
MER2811	50PCS	350PCS	350PCS

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Reflow curve

※ Reflow Profile



1. Reflow Soldering Method

Reflow Soldering	Tp:255~260℃	Max.30 seconds (tp)
	217℃	60~150 seconds
Pre-Heat	150 ~ 200℃	60~120 seconds
Time 25℃ to peak temperature	8 minutes max.	

2. Soldering iron method： 350±5℃ Max.3 seconds.